



17-20 October 2019
Hotel Grand Hyatt, Kochi, Kerala
Technology, Knowledge, and Society

CALL FOR PAPERS- Special session on Artificial intelligence for wireless networks (AIWNs).

Important Dates:

- **Submission Deadline: June 30,2019**
- **Paper Notification date: August 15,2019**
- **Camera Ready: August 30,2019**

Organizers:

- **Dr. Lincy Elizebeth Jim, MIT, Australia**
- **Dr. Mark Gregory, RMIT, Australia**
- **Dr. Shuo Li, RMIT, Australia**
- **Dr. Karina Gomez Chavez, RMIT, Australia**

TENCON is a premier international technical conference of IEEE Region 10. The Theme for TENCON 2019 is Technology, Knowledge, and Society, and it will be held on 17th to 20th October 2019 at Hotel Grand Hyatt, Bolgatty, Kochi, Kerala, India.

Original contributions based on the results of research and developments are solicited. Prospective authors are requested to submit their papers in not more than 6 pages, prepared in the two column IEEE format. All the accepted and presented papers will be published in the form of e-proceedings. We welcome submissions for TENCON's special session in the Artificial intelligence for wireless networks (AIWNs).

Aim and Scope:

Artificial intelligence for wireless networks (AIWNs) is an umbrella term for the use of big data analytics, machine learning (ML) and other artificial intelligence (AI) technologies to automate the identification and resolution of common wireless network issues not limited to network



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performance and security. The researcher is invited to submit papers utilising AI to offer benefit to Wireless Networks not limited to Mobile Ad hoc Networks and WSN.

Paper Submission Guidelines:

Papers for presentations should conform to the IEEE format and specifications. All submissions must be in English only.

Authors are invited to submit full paper (Maximum 6 pages, double-column US letter size) as PDF using the IEEE templates. The IEEE paper template can be downloaded from the link given below.

http://www.ieee.org/conferences_events/conferences/publishing/templates.html.

Submissions are to be done through the TENCON website www.tencon2019.org